AUTOMOTIVE MOSFET

S1 💷

G1 □

S2 💷

G2 🖽

International

55V

0.043Ω

0.050Ω

5.1A

AUIRF7341Q

HEXFET[®] Power MOSFET

typ.

max.

V_{(BR)DSS}

R_{DS(on)}

 I_D

Features

- Advanced Planar Technology
- Ultra Low On-Resistance
- Dual N Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- 175°C Operating Temperature
- Automotive [Q101] Qualified
- Lead-Free, RoHS Compliant

Description

Specifically designed for Automotive applications, these HEXFET® Power MOSFET's in a Dual SO-8 package utilize the lastest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of these Automotive qualified HEXFET Power MOSFET's are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These benefits combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

The efficient SO-8 package provides enhanced thermal characteristics and dual MOSFET die capability making it ideal in a variety of power applications. This dual, surface mount SO-8 can dramatically reduce board space and is also available in Tape & Reel.

Absolute Maximum Ratings

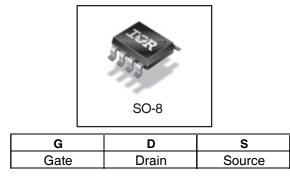
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units	
/ _{DS} Drain-Source Voltage		55	V	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	5.1		
_D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	4.2	А	
ОМ	Pulsed Drain Current ①	42		
P _D @T _A = 25°C	Power Dissipation ③	2.4	w	
P _D @T _A = 70°C	Power Dissipation ③	1.7	v	
	Linear Derating Factor	16	mW/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy [®]	140	mJ	
AR	Avalanche Current	5.1	А	
E _{AR}	Repetitive Avalanche Energy	See Fig. 16,17,14a, 14b	mJ	
ТJ	Operating Junction and	-55 to + 175	°C	
T _{STG}	Storage Temperature Range	-55 10 + 175		

Thermal Resistance

	Parameter	Max.	Units
R _{0JA}	Junction-to-Ambient ④	62.5	°C/W

HEXFET[®] is a registered trademark of International Rectifier. *Qualification standards can be found at http://www.irf.com/



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5 TT D2

Top View

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.052		V/°C	Reference to 25° C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		0.043	0.050		V _{GS} = 10V, I _D = 5.1A ③
			0.056	0.065	Ω	V _{GS} = 4.5V, I _D = 4.42A③
V _{GS(th)}	Gate Threshold Voltage	1.0		3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
gfs	Forward Transconductance	10.4			S	$V_{DS} = 10V, I_{D} = 5.2A$
I _{DSS}	Drain-to-Source Leakage Current			2.0		$V_{DS} = 44V, V_{GS} = 0V$
				25	μA	$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	n۸	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V

Dynamic Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	5 (1 /			
	Parameter	Min.	Тур.	Max.	Units	Conditions			
Q _g	Total Gate Charge		29	44		I _D = 5.2A			
Q _{gs}	Gate-to-Source Charge		2.9	4.4	nC	$V_{DS} = 44V$			
Q _{gd}	Gate-to-Drain ("Miller") Charge		7.3	11		$V_{GS} = 10V$			
t _{d(on)}	Turn-On Delay Time		9.2			$V_{DD} = 28V$			
t _r	Rise Time		7.7			I _D = 1.0A			
t _{d(off)}	Turn-Off Delay Time		31		ns	$R_{G} = 6.0\Omega$			
t _f	Fall Time		12.5			V _{GS} = 10V ③			
C _{iss}	Input Capacitance		780			$V_{GS} = 0V$			
C _{oss}	Output Capacitance		190		pF	$V_{DS} = 25V$			
C _{rss}	Reverse Transfer Capacitance		66			f = 1.0MHz			

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
I _S	Continuous Source Current			2.4		MOSFET symbol	
	(Body Diode)			2.4	•	showing the	
I _{SM}	Pulsed Source Current			42	A	egral reverse	
	(Body Diode) ①			42		p-n junction diode.	
V _{SD}	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C, I_S = 2.6A, V_{GS} = 0V$ (3)	
t _{rr}	Reverse Recovery Time		51	77	-	$T_{\rm J} = 25^{\circ} {\rm C}, {\rm I}_{\rm F} = 2.6{\rm A}$	
Q _{rr}	Reverse Recovery Charge		76	114	nC	di/dt = 100A/µs	

Notes:

 $\ensuremath{\mathbbm O}$ Repetitive rating; pulse width limited by max. junction temperature.

 $@~V_{DD}$ = 25V, starting T_J = 25°C, L = 10.7mH, R_G = 25 $\Omega,~I_{AS}$ = 5.2A.

3 Pulse width \leq 300µs; duty cycle \leq 2%.

 Surface mounted on $\mbox{ FR-4 board, } t \leq \mbox{ 10sec.}$

Qualification Information[†]

		Automotive					
		(per AEC-Q101) ^{††}					
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture Sensitivity Level		SO-8 MSL1					
	Machine Model		Class M2(+/-200V) ^{†††}				
		(per AEC-Q101-002)					
ESD	Human Body Model	Class H1A(+/-500V) ^{†††}					
230		(per AEC-Q101-001)					
	Charged Device	Class C5(+/-1125V) ^{†††}					
	Model	(per AEC-Q101-005)					
RoHS Compliant		Yes					

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

the Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

††† Highest passing voltage

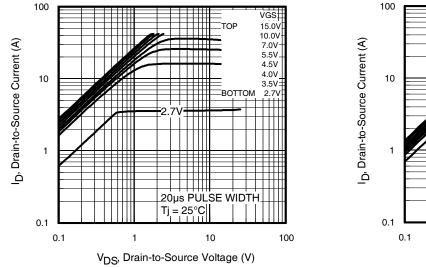


Fig 1. Typical Output Characteristics

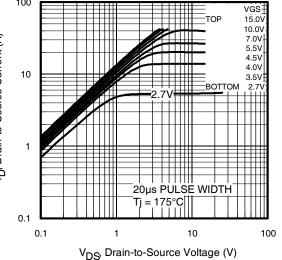


Fig 2. Typical Output Characteristics

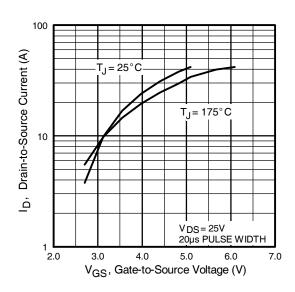


Fig 3. Typical Transfer Characteristics

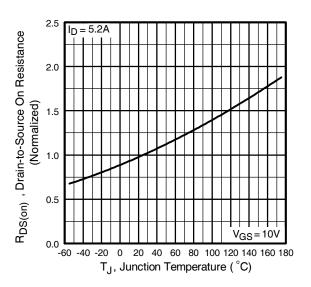


Fig 4. Normalized On-Resistance Vs. Temperature

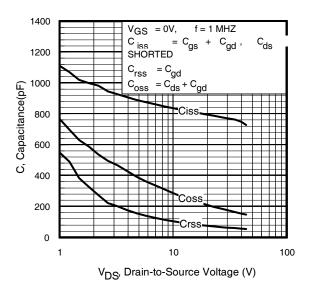
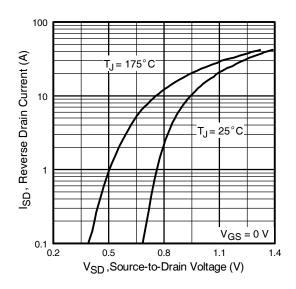
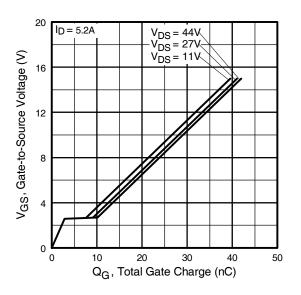


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage









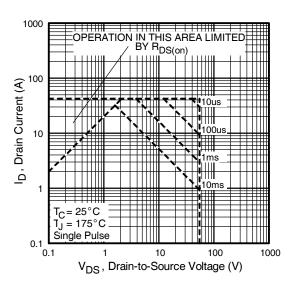


Fig 8. Maximum Safe Operating Area

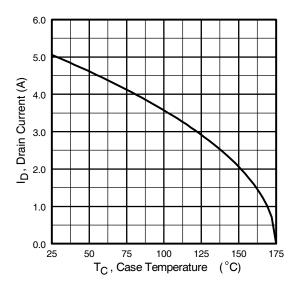


Fig 9. Maximum Drain Current Vs. Case Temperature

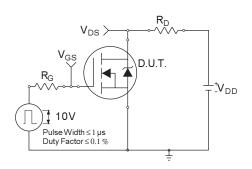


Fig 10a. Switching Time Test Circuit

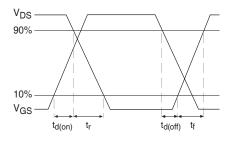


Fig 10b. Switching Time Waveforms

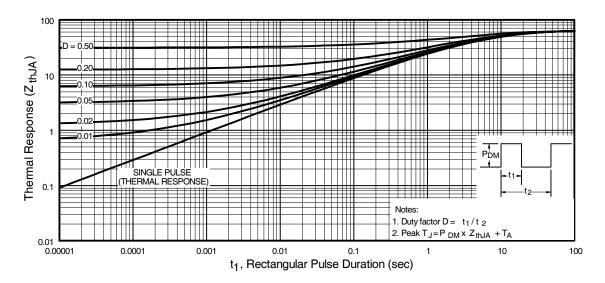


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

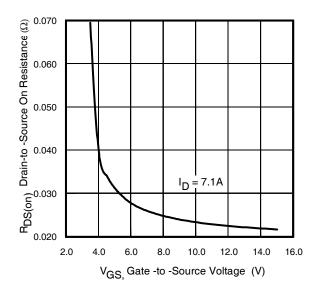


Fig 11. Typical On-Resistance Vs. Gate Voltage

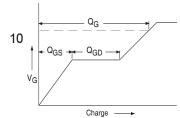


Fig 13a. Basic Gate Charge Waveform

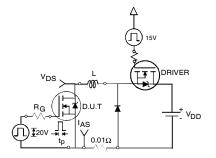


Fig 14a. Unclamped Inductive Test Circuit

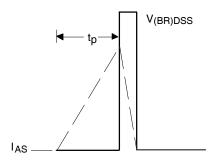
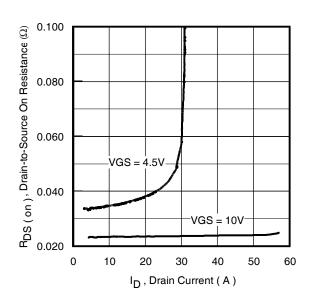
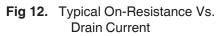


Fig 14b. Unclamped Inductive Waveforms





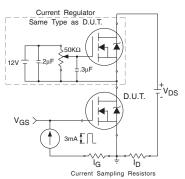


Fig 13b. Gate Charge Test Circuit

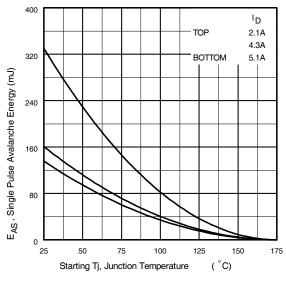


Fig 15. Maximum Avalanche Energy Vs. Drain Current

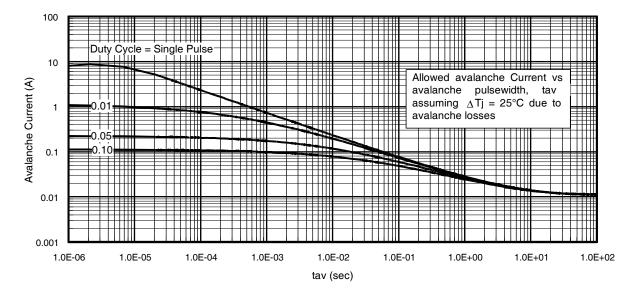


Fig 16. Typical Avalanche Current Vs.Pulsewidth

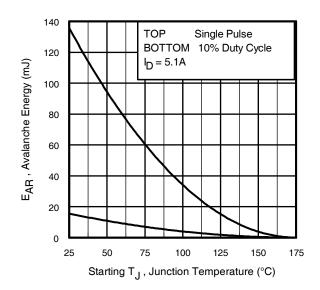


Fig 17. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 16, 17: (For further info, see AN-1005 at www.irf.com)

1. Avalanche failures assumption:

- Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long $asT_{jmax}\ is$ not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 14a, 14b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16). t_{av} = Average time in avalanche.
 - $D = Duty cycle in avalanche = t_{av} \cdot f$
 - $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} \textbf{P}_{D~(ave)} &= 1/2~(~1.3\text{\cdot}BV\text{\cdot}I_{av}) = \bigtriangleup T/Z_{thJC}\\ \textbf{I}_{av} &= 2\bigtriangleup T/~[1.3\text{\cdot}BV\text{\cdot}Z_{th}]\\ \textbf{E}_{AS~(AR)} &= \textbf{P}_{D~(ave)}\text{\cdot}t_{av} \end{split}$$

International **TOR** Rectifier

AUIRF7341Q

MAX

1.75

0.25

0.51

0.25

5.00

4.00

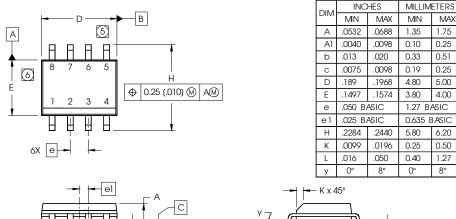
6.20

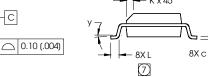
0.50

1.27 8°

SO-8 Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.

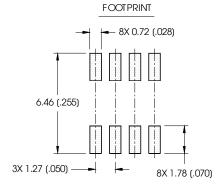
A1

2. CONTROLLING DIMENSION: MILLIMETER

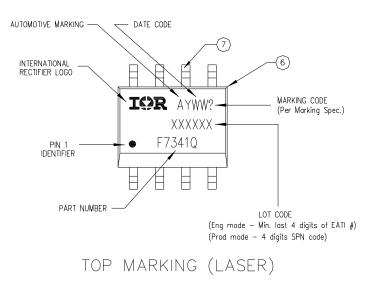
8X b

⊕ 0.25 (.010)
 ∭ C A B

- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO ASUBSTRATE.



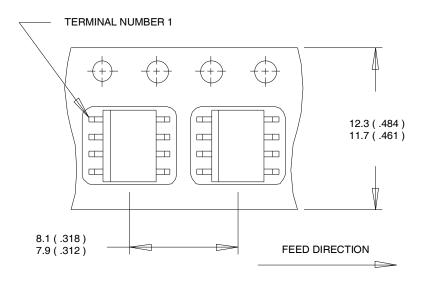
SO-8 Part Marking



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/ www.irf.com

SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)

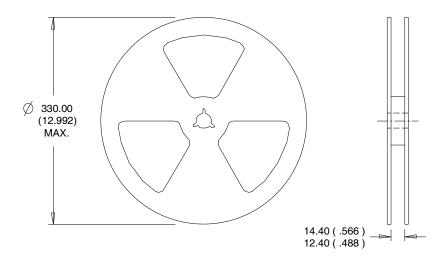


NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.

2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).

3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.

2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Ordering Information

Base part	Package Type	Standard Pack	Complete Part Number	
		Form	Quantity	
AUIRF7341Q	SO-8	Tube	95	AUIRF7341Q
		Tape and Reel	4000	AUIRF7341QTR

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